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August 2006



Features

■ 3.2 A, 20 V.

 $R_{DS(ON)} = 90 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$ $R_{DS(ON)} = 130 \text{ m}\Omega @ V_{GS} = 2.5 \text{ V}$

Low gate charge

FAIRCHILD SEMICONDUCTOR

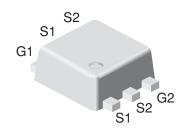
- High performance trench technology for extremely low R_{DS(ON)}
- FLMP SC75 package: Enhanced thermal performance in industry-standard package size

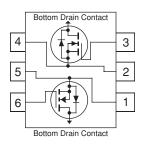
Applications

Battery management

General Description

This dual N-Channel 2.5V specified MOSFET uses Fairchild's advanced low voltage Power Trench process. Packaged in FLMP SC75, the $R_{DS(ON)}$ and thermal properties of the device are optimized for battery power management applications.





Absolute Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		20	V
V _{GSS}	Gate-Source Voltage		±12	V
I _D	Drain Current – Continuous	(Note 1a)	3.2	A
	- Pulsed		12	
P _D	Power Dissipation for single Operation	(Note 1a)	1.5	W
T _J , T _{STG}	Operating and Storage Junction Temperatur	e Range	-55 to +150	°C
Thermal Cha	aracteristics			,
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)		80	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		5	

Packge Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
.F	FDJ1028N	7"	8mm	3000 units

FDJ1028N
N-Channel
N-Channel 2.5 Vgs Specified PowerTrench [®] N
d PowerTrench [®]
MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Charact	eristics		1	1	1	
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		13		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 16 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 12 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Charact	eristics (Note 2)	•				
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	0.6	1.0	1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$\begin{array}{c} V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 3.2 \text{ A} \\ V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 2.7 \text{ A} \\ V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 3.2 \text{ A}, \text{ T}_{J} = 125^{\circ}\text{C} \end{array}$	70 100 5°C 83		90 130 132	mΩ
9 _{FS}	Forward Transconductance	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 3.2 \text{ A}$		7.5		S
Dynamic C	haracteristics					
C _{iss}	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		200		pF
C _{oss}	Output Capacitance			50		pF
C _{rss}	Reverse Transfer Capacitance			30		pF
R _G	Gate Resistance	f = 1.0 MHz		3		Ω
Switching (Characteristics (Note 2)	•				
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A}, \\ V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		7	14	ns
t _r	Turn–On Rise Time			8	16	ns
t _{d(off)}	Turn–Off Delay Time			11	20	ns
t _f	Turn–Off Fall Time			2	4	ns
Qg	Total Gate Charge	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 3.2 \text{ A},$		2	3	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 4.5 V$		0.4		nC
Q _{gd}	Gate-Drain Charge			1.0		nC
Drain-Sour	ce Diode Characteristics and Maximur	n Ratings				
I _S	Maximum Continuous Drain-Source Did	ode Forward Current			1.25	A
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 1.25 A (Note 2)		0.8	1.2	V
t _{rr}	Diode Reverse Recovery Time	I _F = 3.2 A,		11		nS
Q _{rr}	Diode Reverse Recovery Charge	[─] d _{iF} /d _t = 100 A/µs		2.5		nC

Notes:

1. R_{BJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{BJC} is guaranteed by design while R_{BCA} is determined by the user's board design.

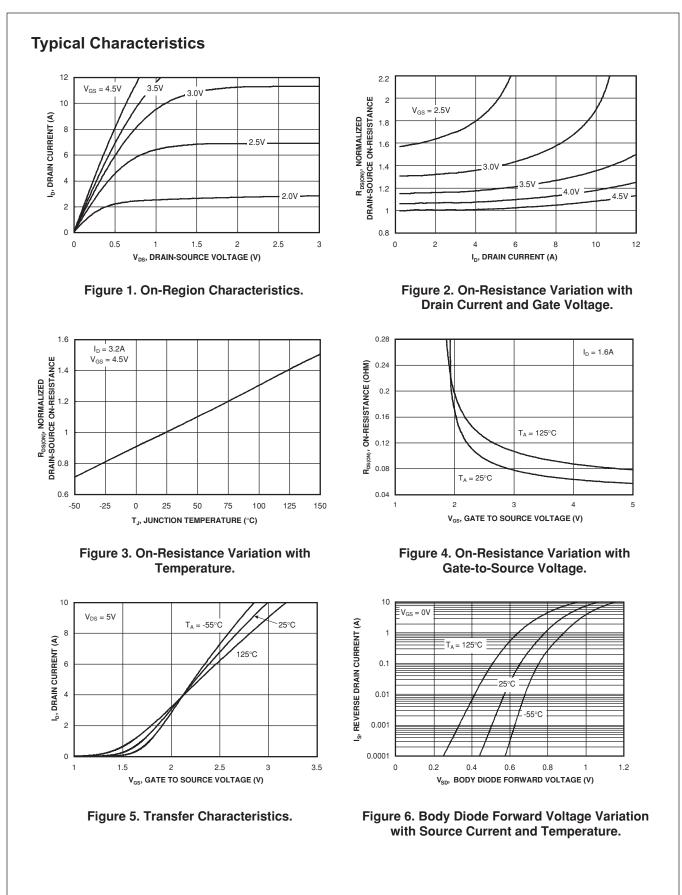


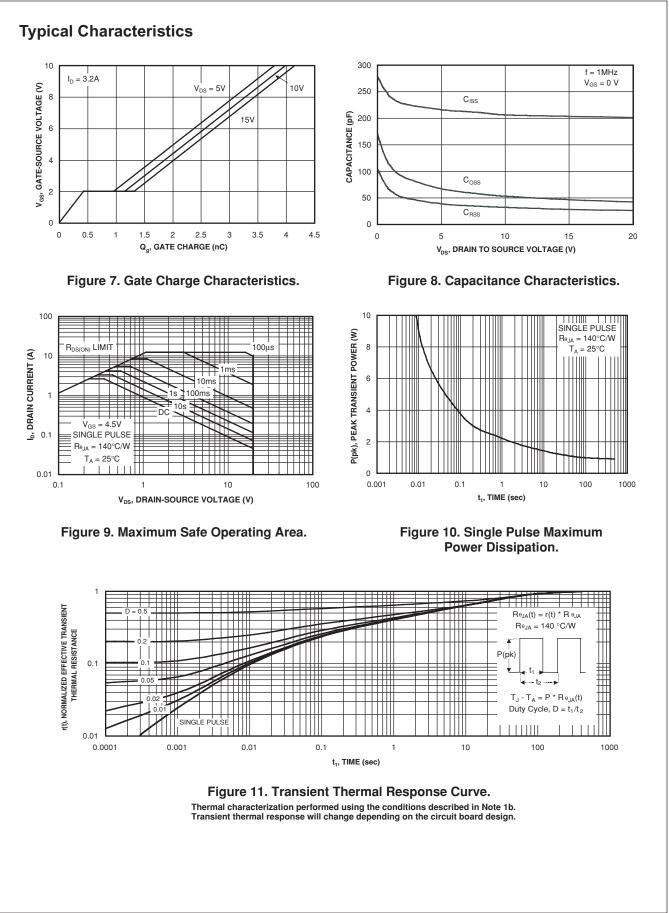
 a) 80°C/W when mounted on a 1in² pad of 2 oz copper (Single Operation).

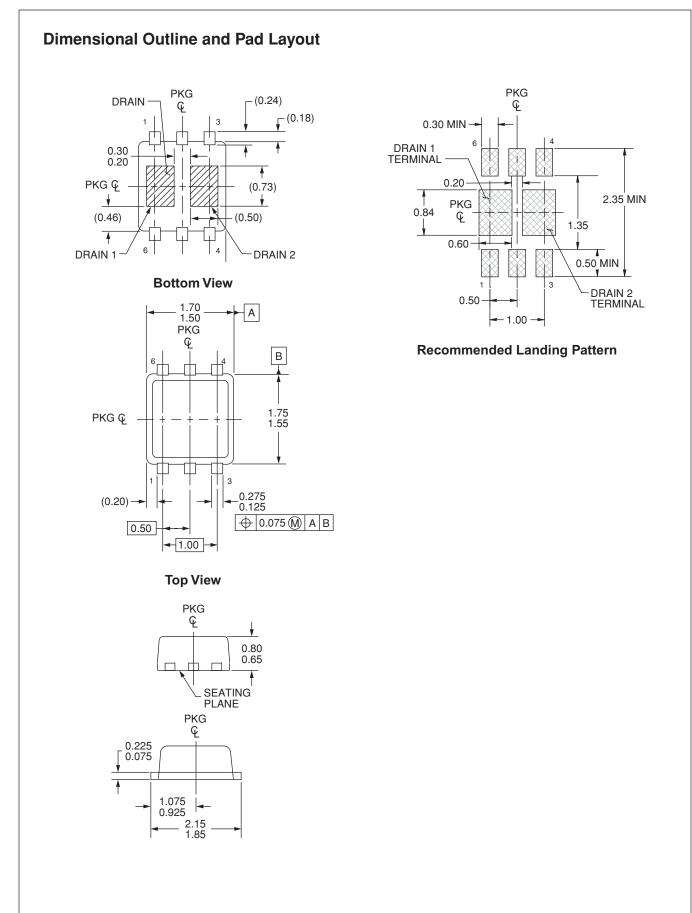


b) 140°C/W when mounted on a minimum pad of 2 oz copper (Single Operation).

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%







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